## NLAS7222B, NLAS7222C

## High-Speed USB 2.0 (480 Mbps) DPDT Switches

ON Semiconductor's NLAS7222B and NLAS7222C are part of a series of analog switch circuits that are produced using the company's advanced sub-micron CMOS technology, achieving industry-leading performance.

Both the NLAS7222B and NLAS7222C are 2- to 1-port analog switches. Their wide bandwidth and low bit-to-bit skew allow them to pass high-speed differential signals with good signal integrity. Each switch is bidirectional and offers little or no attenuation of the high-speed signals at the outputs. Industry-leading advantages include a propagation delay of less than 250 ps , resulting from its low channel resistance and low I/O capacitance. Their high channel-to-channel crosstalk rejection results in minimal noise interference. Their bandwidth is wide enough to pass High-Speed USB 2.0 differential signals ( $480 \mathrm{Mb} / \mathrm{s}$ ).

## Features

- $\mathrm{R}_{\mathrm{ON}}$ is Typically $8.0 \Omega$ at $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$
- Low Bit-to-Bit Skew: Typically 50 ps
- Low Crosstalk: -30 dB @ 250 MHz
- Low Current Consumption: $1.0 \mu \mathrm{~A}$
- Near-Zero Propagation Delay: 250 ps
- Channel On-Capacitance: 8.0 pF (Typical)
- $\mathrm{V}_{\mathrm{CC}}$ Operating Range: 1.65 V to 4.5 V
- $>700 \mathrm{MHz}$ Bandwidth (or Data Frequency)
- These are Pb -Free Devices


## Typical Applications

- Differential Signal Data Routing
- USB 2.0 Signal Routing


## Important Information

- Continuous Current Rating Through Each Switch $\pm 50 \mathrm{~mA}$
- 8 kV I/O to GND ESD Protection

ON Semiconductor ${ }^{\circledR}$
http://onsemi.com


## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.


Figure 1. Pin Connections and Logic Diagram
(NLAS7222B, Top View)
Table 1. PIN DESCRIPTION

| Pin | Function |
| :---: | :--- |
| S | Select Input |
| $\overline{\mathrm{OE}}$ | Output Enable |
| HSD1+, HSD1-, HSD2+, <br> HSD2-, D+, D- | Data Ports |



Figure 2. Pin Connections and Logic Diagram
(NLAS7222C, Top View)
Table 2. TRUTH TABLE

| OE | $\mathbf{S}$ | HSD1+, <br> HSD1- | HSD2+, <br> HSD2- |
| :---: | :---: | :---: | :---: |
| 1 | X | OFF | OFF |
| 0 | 0 | ON | OFF |
| 0 | 1 | OFF | ON |

MAXIMUM RATINGS

| Symbol | Pins | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {cc }}$ | $\mathrm{V}_{\mathrm{CC}}$ | Positive DC Supply Voltage | -0.5 to +5.5 | V |
| $\mathrm{V}_{\text {IS }}$ | $\begin{aligned} & \text { HSD1+, HSD1- } \\ & \text { HSD2+, HSD2- } \end{aligned}$ | Analog Signal Voltage | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.3$ | V |
|  | D+, D- |  | -0.5 to +5.5 |  |
| VIN | OE | Control Input Voltage | -0.5 to +5.5 | V |
| ICC | $\mathrm{V}_{\mathrm{CC}}$ | Positive DC Supply Current | 50 | mA |
| $\mathrm{T}_{\text {S }}$ |  | Storage Temperature | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| IIs_CON | $\begin{gathered} \hline \text { HSD1+, HSD1- } \\ \text { HSD2+, HSD2-, } \\ \text { D+, D- } \end{gathered}$ | Analog Signal Continuous Current-Closed Switch | $\pm 300$ | mA |
| IIS_PK | $\begin{gathered} \hline \text { HSD1+, HSD1- } \\ \text { HSD2+, HSD2-, } \\ \text { D+, D- } \end{gathered}$ | Analog Signal Continuous Current 10\% Duty Cycle | $\pm 500$ | mA |
| $\mathrm{I}_{\mathrm{N}}$ | OE | Control Input Current | $\pm 20$ | mA |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Pins | Parameter | Min | Max | Unit |
| :--- | :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ |  | Positive DC Supply Voltage | 1.65 | 4.5 | V |
| $\mathrm{~V}_{\mathrm{IS}}$ | HSD1+, HSD1- <br> HSD2+, HSD2- | Analog Signal Voltage | GND | $\mathrm{V}_{\mathrm{CC}}$ | V |
|  | $\mathrm{D}+, \mathrm{D}-$ |  | GND | 4.5 |  |
|  | OE | Digital Select Input Voltage | GND | $\mathrm{V}_{\mathrm{CC}}$ | V |
|  |  | Operating Temperature Range | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |

Minimum and maximum values are guaranteed through test or design across the Recommended Operating Conditions, where applicable. Typical values are listed for guidance only and are based on the particular conditions listed for section, where applicable. These conditions are valid for all values found in the characteristics tables unless otherwise specified in the test conditions.

ESD PROTECTION

| Symbol | Parameter | Value | Unit |
| :--- | :--- | :---: | :---: |
| ESD | Human Body Model - All Pins | 2.0 | kV |
| ESD | Human Body Model - I/O to GND | 8.0 | kV |

## DC ELECTRICAL CHARACTERISTICS

CONTROL INPUT (Typical: $\mathrm{T}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ )

| Symbol | Pins | Parameter | Test Conditions | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min | Typ | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | $\overline{\mathrm{OE}}$ | Control Input HIGH <br> Voltage (See Figure 3) |  | $\begin{aligned} & 2.7 \\ & 3.3 \\ & 4.2 \end{aligned}$ | $\begin{aligned} & 1.3 \\ & 1.4 \\ & 1.6 \end{aligned}$ | - | - | V |
| $\mathrm{V}_{\mathrm{IL}}$ | $\overline{\mathrm{OE}}$ | Control Input LOW <br> Voltage (See Figure 3) |  | $\begin{aligned} & 2.7 \\ & 3.3 \\ & 4.2 \end{aligned}$ | - |  | $\begin{aligned} & 0.4 \\ & 0.4 \\ & 0.5 \end{aligned}$ | V |
| $\mathrm{I}_{\mathrm{N}}$ | OE | Control Input Leakage Current | $0 \leq \mathrm{V}_{\text {IS }} \leq \mathrm{V}_{\text {CC }}$ | 1.65-4.5 | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |

SUPPLY AND LEAKAGE CURRENT (Typical: $\mathrm{T}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ )

| Symbol | Pins | Parameter | Test Conditions | Vcc (V) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min | Typ | Max |  |
| ICC | $\mathrm{V}_{\mathrm{CC}}$ | Quiescent Supply Current | $\mathrm{V}_{\text {IS }}=\mathrm{V}_{\mathrm{CC}}$ or GND; I IOUT $=$ 0 A | 1.65-4.5 | - | - | 1.0 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {CCT }}$ | $\mathrm{V}_{\mathrm{CC}}$ | Increase in Icc per Control Voltage | $\mathrm{V}_{\text {IN }}=2.6 \mathrm{~V}$ | 3.6 | - | - | 10 | $\mu \mathrm{A}$ |
| l Oz | HSD1+, HSD1HSD2+, HSD2- | OFF State <br> Leakage Current | $0 \leq \mathrm{V}_{\text {IS }} \leq \mathrm{V}_{\text {CC }}$ | 1.65-4.5 | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| IOFF | D+, D- | Power OFF <br> Leakage Current | $0 \leq \mathrm{V}_{\text {IS }} \leq 4.5 \mathrm{~V}$ | 0 | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |

HIGH SPEED ON RESISTANCE (Typical: $\mathrm{T}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ )

| Symbol | Pins | Parameter | Test Conditions | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min | Typ | Max |  |
| RON |  | On-Resistance | $\begin{aligned} & \mathrm{V}_{\mathrm{IS}}=0 \mathrm{~V} \text { to } 0.4 \mathrm{~V}, \mathrm{ION}= \\ & 8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 3.3 \\ & 4.2 \end{aligned}$ | - | $\begin{aligned} & \hline 9.0 \\ & 8.0 \\ & 7.0 \end{aligned}$ | $\begin{aligned} & 12 \\ & 10 \\ & 8.0 \end{aligned}$ | $\Omega$ |
| RFLAT |  | On-Resistance Flatness | $\begin{aligned} & \mathrm{V}_{\mathrm{IS}}=0 \mathrm{~V} \text { to } 1.0 \mathrm{~V}, \mathrm{I}_{\mathrm{ON}}= \\ & 8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 3.3 \\ & 4.2 \end{aligned}$ | - | $\begin{aligned} & 1.6 \\ & 1.5 \\ & 1.4 \end{aligned}$ | - | $\Omega$ |
| $\Delta \mathrm{R}_{\mathrm{ON}}$ |  | On-Resistance Matching | $\begin{aligned} & \mathrm{V}_{\mathrm{IS}}=0 \mathrm{~V} \text { to } 0.4 \mathrm{~V}, \mathrm{ION}_{\mathrm{ON}}= \\ & 8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 3.3 \\ & 4.2 \end{aligned}$ | - | $\begin{aligned} & 1.05 \\ & 0.85 \\ & 0.65 \end{aligned}$ | - | $\Omega$ |

DC ELECTRICAL CHARACTERISTICS (continued)
FULL SPEED ON RESISTANCE (Typical: $\mathrm{T}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}$ )

| Symbol | Pins | Parameter | Test Conditions | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min | Typ | Max |  |
| $\mathrm{R}_{\text {ON }}$ |  | On-Resistance | $\begin{aligned} & \mathrm{V}_{\mathrm{IS}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}}, \mathrm{I}_{\mathrm{ON}}= \\ & 8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 3.3 \\ & 4.2 \end{aligned}$ |  | $\begin{aligned} & 9.0 \\ & 8.5 \\ & 7.5 \end{aligned}$ | $\begin{gathered} 12 \\ 10.5 \\ 8.5 \end{gathered}$ | $\Omega$ |
| $\mathrm{R}_{\text {FLAT }}$ |  | On-Resistance Flatness | $\begin{aligned} & \mathrm{V}_{\mathrm{IS}}=0 \mathrm{~V} \text { to } 1.0 \mathrm{~V} \text {, } \mathrm{ION}= \\ & 8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 3.3 \\ & 4.2 \end{aligned}$ |  | 1.6 1.5 1.4 |  | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ |  | On-Resistance Matching | $\begin{aligned} & \mathrm{V}_{\mathrm{IS}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{CC}}, \mathrm{I}_{\mathrm{ON}}= \\ & 8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 2.7 \\ & 3.3 \\ & 4.2 \end{aligned}$ |  | $\begin{aligned} & 2.20 \\ & 2.45 \\ & 2.65 \end{aligned}$ |  | $\Omega$ |

## AC ELECTRICAL CHARACTERISTICS

TIMING/FREQUENCY (Typical: $\mathrm{T}=2^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ )

| Symbol | Pins | Parameter | Test Conditions | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min | Typ | Max |  |
| $\mathrm{t}_{\mathrm{ON}}$ | Closed to Open | Turn-ON Time |  | 1.65-4.5 | - | 14 | 30 | ns |
| tofF | Open to Closed | Turn-OFF Time |  | 1.65-4.5 | - | 10 | 20 | ns |
| $\mathrm{t}_{\text {BBM }}$ |  | Break-Before-Make Delay |  | 1.65-4.5 | 3.0 | 4.4 | 7.0 | ns |
| BW |  | -3 dB Bandwidth | $\mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ | 1.65-4.5 | - | 500 | - | MHz |
|  |  |  | $\mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}$ |  | - | 750 | - |  |

ISOLATION (Typical: $\mathrm{T}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ )

| Symbol | Pins | Parameter | Test Conditions | $\mathrm{V}_{\mathrm{Cc}}(\mathrm{V})$ | $-40{ }^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min | Typ | Max |  |
| $\mathrm{O}_{\text {IRR }}$ | Open | OFF-Isolation | $\mathrm{f}=250 \mathrm{MHz}$ | 1.65-4.5 | - | -22 | - | dB |
| $\mathrm{X}_{\text {TALK }}$ | $\begin{gathered} \hline \text { HSD1+ to } \\ \text { HSD1- } \end{gathered}$ | Non-Adjacent Channel Crosstalk | $\mathrm{f}=250 \mathrm{MHz}$ | 1.65-4.5 | - | -30 | - | dB |

NLAS7222B CAPACITANCE (Typical: $\mathrm{T}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ )

| Symbol | Pins | Parameter | Test Conditions | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| $\mathrm{C}_{\text {IN }}$ | $\overline{\mathrm{OE}}$ | Control Pin Input Capacitance | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ | - | 3.0 | - | pF |
| $\mathrm{Con}^{\text {a }}$ | $\begin{gathered} \text { D+ to } \\ \text { HSD1+ or } \\ \text { HSD2+ } \end{gathered}$ | ON Capacitance | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} ; \overline{\mathrm{OE}}=0 \mathrm{~V}$ | - | 8.0 | - | pF |
| CofF | $\begin{aligned} & \hline \text { HSD2+, } \\ & \text { HSD2- } \end{aligned}$ | OFF Capacitance | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{IS}}=3.3 \mathrm{~V} ; \overline{\mathrm{OE}}= \\ & 3.3 \mathrm{~V} \end{aligned}$ | - | 4.5 | - | pF |

NLAS7222C CAPACITANCE (Typical: $\mathrm{T}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz}$ )

| Symbol | Pins | Parameter | Test Conditions | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| $\mathrm{C}_{\mathrm{IN}}$ | $\overline{\mathrm{OE}}$ | Control Pin Input Capacitance | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ | - | 3.0 | - | pF |
| $\mathrm{Con}^{\text {a }}$ | $\begin{gathered} \text { D+ to } \\ \text { HSD1+ or } \\ \text { HSD2+ } \end{gathered}$ | ON Capacitance | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} ; \overline{\mathrm{OE}}=0 \mathrm{~V}$ | - | 10 | - | pF |
| $\mathrm{C}_{\text {OFF }}$ | $\begin{aligned} & \hline \text { HSD2+, } \\ & \text { HSD2- } \end{aligned}$ | OFF Capacitance | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{IS}}=3.3 \mathrm{~V} ; \overline{\mathrm{OE}=} \\ & 3.3 \mathrm{~V} \end{aligned}$ | - | 5.5 | - | pF |



Figure 3. ICc vs. $\mathrm{V}_{\mathrm{IN}}$


Figure 4. $\mathrm{t}_{\mathrm{BBM}}$ (Time Break-Before-Make)


Figure 5. $\mathrm{t}_{\mathrm{ON}} / \mathrm{t}_{\mathrm{OFF}}$


Figure 6. $\mathrm{t}_{\mathrm{ON}} / \mathrm{t}_{\mathrm{OFF}}$

NLAS7222B, NLAS7222C


Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. $\mathrm{V}_{\text {ISO }}$, Bandwidth and $\mathrm{V}_{\text {ONL }}$ are independent of the input signal direction.
$\mathrm{V}_{\text {ISO }}=$ Off Channel Isolation $=20 \mathrm{Log}\left(\frac{\mathrm{VOUT}^{V_{I N}}}{\mathrm{~V}_{\mathrm{IN}}}\right)$ for $\mathrm{V}_{\text {IN }}$ at 100 kHz
$\mathrm{V}_{\mathrm{ONL}}=$ On Channel Loss $=20 \log \left(\frac{\mathrm{~V}_{\mathrm{OUT}}}{\mathrm{V}_{\mathrm{IN}}}\right)$ for $\mathrm{V}_{\mathrm{IN}}$ at 100 kHz to 50 MHz
Bandwidth (BW) = the frequency 3 dB below $\mathrm{V}_{\mathrm{ONL}}$
$\mathrm{V}_{\mathrm{CT}}=$ Use $\mathrm{V}_{\text {ISO }}$ setup and test to all other switch analog input/outputs terminated with $50 \Omega$

Figure 7. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/V ${ }_{\text {ONL }}$

## NLAS7222B, NLAS7222C

## APPLICATIONS INFORMATION

The low on resistance and capacitance of the NLAS7222B provides for a high bandwidth analog switch suitable for applications such as USB data switching. Results for the USB 2.0 signal quality tests will be shown in this section, along with a description of the evaluation test board. The data for the eye diagram signal quality and jitter tests verifies that the NLAS7222B can be used as a data switch in low, full and high speed USB 2.0 systems.

Figures 8, 9 and 10 provide a description of the test evaluation board. The USB tests were conducted per the procedures provided by the USB Implementers Forum
(www.usb.org), the industry group responsible for defining the USB certification requirements. The test patterns were generated by a PC and MATLAB software, and were inputted to the analog switch through USB connectors J1 (HSD1) or J2 (HSD2). A USB certified device was plugged into connector J 4 to function as a data transceiver. The high speed and full speed tests used a flash memory device, while the low speed tests used a mouse. Test connectors J3 and J5 provide a direct connection of the USB device and were used to verify that the analog switch does not distort the data signals.


Figure 8. Schematic of the NLAS7222B USB Demo Board


Figure 9. Block Diagram of the NLAS7222B USB Demo Board


Figure 10. Photograph of the NLAS7222B USB Demo Board

ORDERING INFORMATION

| Device | Package | Shipping $\dagger$ |
| :---: | :---: | :---: |
| NLAS7222BMUTBG | UQFN-10 <br> (Pb-Free) | $3000 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## PACKAGE DIMENSIONS

10 PIN UQFN, $1.4 \times 1.8,0.4 P$
CASE 488AT-01
ISSUE O


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS

|  | MILLIMETERS |  |
| :---: | :---: | :---: |
| DIM | MIN | MAX |
| A | 0.45 | 0.60 |
| A1 | 0.00 | 0.05 |
| b | 0.15 | 0.05 |
| D | 1.40 BSC |  |
| E | 1.80 BSC |  |
| e | 0.40 BSC |  |
| L | 0.30 | 0.50 |
| L3 | 0.40 | 0.60 |

## MOUNTING FOOTPRINT*


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

[^0]
## PUBLICATION ORDERING INFORMATION

## LITERATURE FULFILLMENT

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